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2SD1436(K)

Silicon NPN Triple Diffused

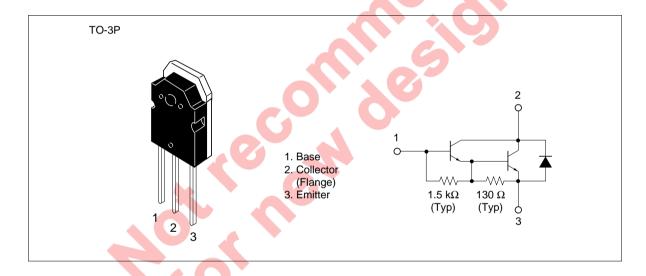


ADE-208-911 (Z) 1st. Edition September 2000

Application

Power switching complementary pair with 2SB1032(K)

Outline



2SD1436(K)

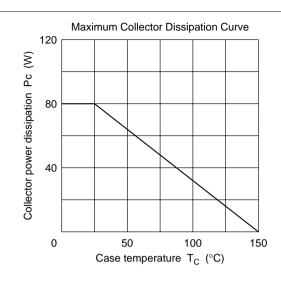
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

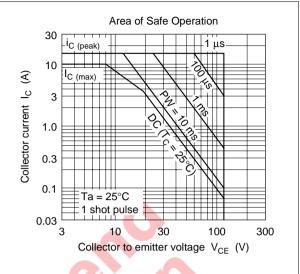
Item	Symbol	Rating	Unit	
Collector to base voltage	V_{CBO}	120	V	
Collector to emitter voltage	V_{CEO}	V _{CEO} 120		
Emitter to base voltage	V_{EBO}	V _{EBO} 7		
Collector current	I _c	I _c 10		
Collector peak current	I _{C (peak)}	15	А	
Collector power dissipation	P _c *1	80	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

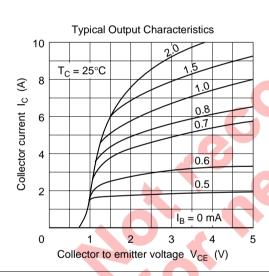
Electrical Characteristics ($Ta = 25^{\circ}C$)

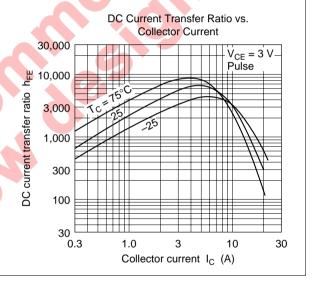
Note: 1. Value at $T_c = 25^{\circ}C$.								
Electrical Characteristics (Ta = 25°C)								
Item	Symbol	Min	Тур	Max	Unit	Test conditions		
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	1	<u> </u>	V	$I_{\rm C}$ = 25 mA, $R_{\rm BE}$ = ∞		
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7		9	V	$I_{\rm E} = 200 \text{ mA}, I_{\rm C} = 0$		
Collector cutoff current	I _{CBO}		-	100	μΑ	$V_{CB} = 120 \text{ V}, I_{E} = 0$		
	I _{CEO}	<u> </u>		10	μΑ	$V_{CE} = 100 \text{ V}, R_{BE} = \infty$		
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{CE} = 3 \text{ V}, I_{C} = 5 \text{ A}^{*1}$		
Collector to emitter saturation	V _{CE (sat)1}	-K	_	1.5	V	$I_{\rm C} = 5 \text{ A}, I_{\rm B} = 10 \text{ mA}^{*1}$		
voltage	V _{CE (sat)2}		_	3.0	V	$I_{\rm C} = 10 \text{ A}, I_{\rm B} = 0.1 \text{ A}^{*1}$		
Base to emitter saturation	V _{BE (sat)1}		_	2.0	V	$I_{\rm C} = 5 \text{ A}, I_{\rm B} = 10 \text{ mA}^{*1}$		
voltage	V _{BE (sat)2}	_	_	3.5	V	$I_{\rm C} = 10 \text{ A}, I_{\rm B} = 0.1 \text{ A}^{*1}$		
Turn on time	Ton	_	0.8	_	μs	$I_{\rm C} = 5 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 10 \text{ mA}$		
Turn off time	Toff	_	4.0	_	μs			

Note: 1. Pulse test.



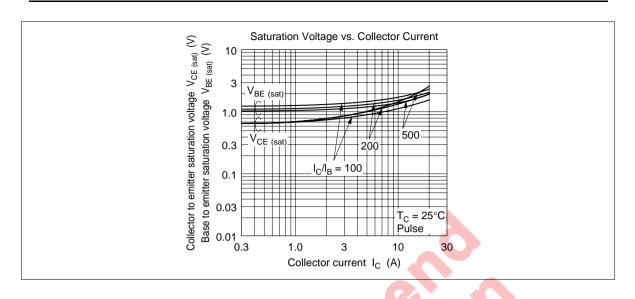






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2SD1436(K)



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